

December 2006

H11L1M, H11L2M, H11L3M 6-Pin DIP Optocoupler

Features

- High data rate, 1MHz typical (NRZ)
- Free from latch up and oscilliation throughout voltage and temperature ranges.
- Microprocessor compatible drive
- Logic compatible output sinks 16mA at 0.4V maximum
- Guaranteed on/off threshold hysteresis
- Wide supply voltage capability, compatible with all popular logic systems
- Underwriters Laboratory (UL) recognized file #E90700, Volume 2
- VDE recognized File#102497 Add option V (e.g., H11LIVM)

Applications

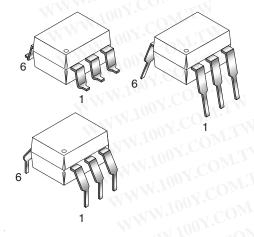
- Logic to logic isolator
- Programmable current level sensor
- Line receiver—eliminate noise and transient problems
- A.C. to TTL conversion—square wave shaping
- Digital programming of power supplies
- Interfaces computers with peripherals

Description

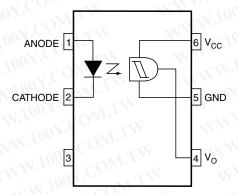
The H11LXM series has a high speed integrated circuit detector optically coupled to a gallium-arsenide infrared emitting diode. The output incorporates a Schmitt trigger, which provides hysteresis for noise immunity and pulse shaping. The detector circuit is optimized for simplicity of operation and utilizes an open collector output for maximum application flexibility.

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Packages



Schematic



Truth Table

Input	Output
100H	M.E
x1 1007.	HI

Absolute Maximum Ratings (T_A = 25°C Unless otherwise specified.)

Symbol	Parameters	Value	Units
TOTAL DEVICE	MAMA TOOK COMMENT MANAGE	Y.CON.TW	
T _{STG}	Storage Temperature	-55 to +150	°C
T _{OPR}	Operating Temperature	-40 to +85	°C
T _{SOL}	Lead Solder Temperature	260 for 10 sec	°C
P _D Total Device Power Dissipation @ 25°C Derate Above 25°C		250	mW
		2.94	mW/°C
EMITTER	WW.100x.COM.TW	W.100 L. COM.	
. IF TW	Continuous Forward Current	60	mA
V _R	Reverse Voltage	106	V
I _F (pk)	Forward Current – Peak (1µs pulse, 300pps)	3.0	A.T. A
P_{D}	LED Power Dissipation 25°C Ambient	120	mW
	Derate Linearly From 25°C	1.41	mW/°C
DETECTOR	· WWW.Ing OV.COM.	WWW.Toox.C	ON
1.100 PD (O)	Detector Power Dissipation @ 25°C	150	mW
N.100Y.	Derate Linearly from 25°C	2.0	mW/°C
Vo	V ₄₅ Allowed Range	0 to 16	V.T
V _{CC}	V ₆₅ Allowed Range	3 to 16	V.
Io V.	I ₄ Output Current	50	mA
MMM.100. MMM.100.	勝 特 力 材 料 886-3-5753170 胜特力电子(上海) 86-21-54151736	N WWW.	100X.CON

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Electrical Characteristics (T_A = 25°C Unless otherwise specified.)

Individual Component Characteristics

Symbol	Parameters	Test Conditions	Device	Min.	Тур.	Max.	Units
EMITTER	W.1007.	V. L. M.	1.100	ONL	-1		
V_{F}	Input Forward Voltage	I _F = 10mA	All	COM	1.2	1.5	V
	WWW.TOOX.Co	$I_F = 0.3 \text{mA}$	1007	0.75	1.0		1
I _R	Reverse Current	$V_R = 3V$	All		1.11	10	μΑ
CJ	Capacitance	V = 0, f = 1.0MHz	All	N.Co.	MIN	100	pF
DETECTOR	W VIWW.	COMMENT	NAME	MY.CC	TT	N	ļ
V_{CC}	Operating Voltage Range	COM	All	3 (OM.	15	V
I _{CC(off)}	Supply Current	$I_F = 0, V_{CC} = 5V$	All	ON.	1.6	5.0	mA
I _{OH}	Output Current, High	$I_F = 0, V_{CC} = V_O = 15V$	All	Too	CO_{M_T}	100	μΑ

Transfer Characteristics

Symbol	Parameter	Test Conditions	Device	Min.	Тур.	Max.	Units
DC CHARA	CTERISTICS	100Y.COM.TW	W	- XX 1	001	OMITY	
I _{CC(on)}	Supply Current	I _F = 10mA, V _{CC} = 5V	All 🔨		1.6	5.0	mA
V _{OL}	Output Voltage, low	$R_{L}= 270\Omega, V_{CC} = 5V,$ $I_{F} = I_{F(on)} \text{ max}.$	All	NNN	0.2	0.4	V
I _{F(on)}	Turn-On Threshold Current ⁽¹⁾	Id Current ⁽¹⁾ $R_L = 270\Omega, V_{CC} = 5V$	H11L1M		11.100	1.6	mA
	DY.COM.TH N		H11L2M	-13	W.100	10.0	17.7
	OV.COM.TW	W. 100Y. CON	H11L3M	W.	N.10	5.0	M_{JJ}
I _{F(off)}	Turn-Off Threshold Current	$R_L = 270\Omega$, $V_{CC} = 5V$	All	0.3	1.0	00 X .	mA
I _{F(off)} /I _{F(on)}	Hysteresis Ratio	$R_L = 270\Omega$, $V_{CC} = 5V$	All	0.50	0.75	0.90	Mon
AC CHARA	CTERISTICS, Switching Spee	d WW 1007.C	WILVE		MAN	J 100Y	
t _{on}	Turn-On time	$R_L = 270\Omega, V_{CC} = 5V,$ $I_F = I_{F(on)}, T_A = 25^{\circ}C$	All	N	1.0	4	μs
t _f	Fall Time	$R_L = 270\Omega, V_{CC} = 5V,$ $I_F = I_{F(on)}, T_{A} = 25^{\circ}C$	All	W	0.1	W.10	μs
t _{off}	Turn-Off Time	$R_L = 270\Omega, V_{CC} = 5V,$ $I_F = I_{F(on)}, T_{A} = 25^{\circ}C$	All	TW	1.2	4	μs
t _r	Rise time	$R_L = 270\Omega, V_{CC} = 5V,$ $I_F = I_{F(on)}, T_A = 25^{\circ}C$	All	M.TW	0.1	WWW	μs
	Data Rate	A AM	All	TIM	1.0	11/1/	MHz

Isolation Characteristics

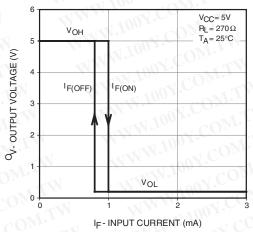
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
V _{ISO}	Input-Output Isolation Voltage	t =1 sec.	7500	COM	W	V _{PEAK}
C _{ISO}	Isolation Capacitance	$V_{I-O} = 0V$, $f = 1MHz$	M.In	0.4	0.6	pF
R _{ISO}	Isolation Resistance	$V_{I-O} = \pm 500 \text{ VDC}$	10 ¹¹	A.COM	TW	Ω

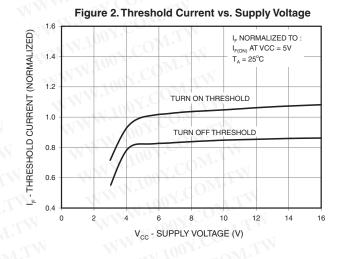
Note:

Maximum I_{F(ON)} is the maximum current required to trigger the output. For example, a 1.6mA maximum trigger current would require the LED to be driven at a current greater than 1.6mA to guarantee the device will turn on. A 10% guard band is recommended to account for degradation of the LED over its lifetime. The maximum allowable LED drive current is 60mA.

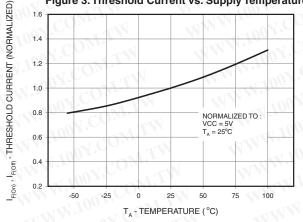
Typical Performance Curves

Figure 1. Transfer Characteristics









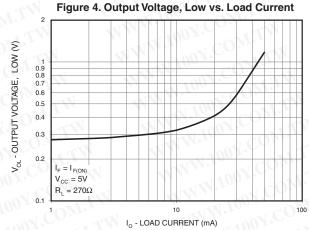
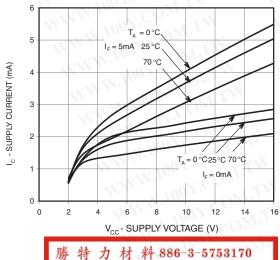
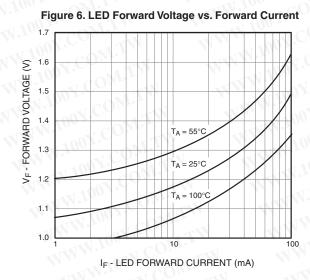


Figure 5. Supply Current vs. Supply Voltage





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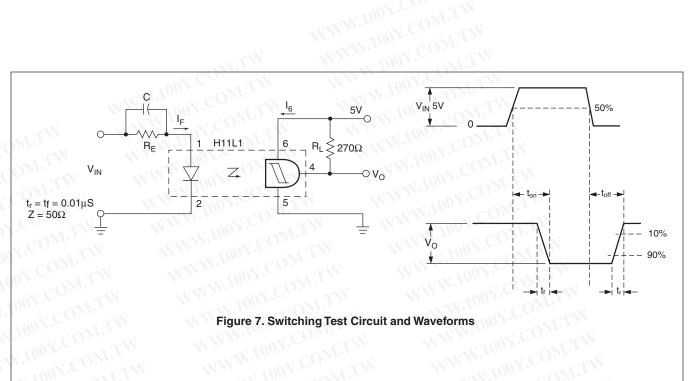


Figure 7. Switching Test Circuit and Waveforms WWW.100Y.COM.TW

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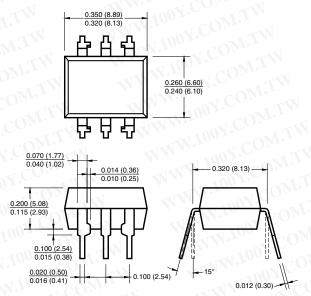
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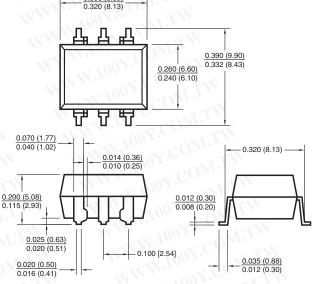
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Package Dimensions

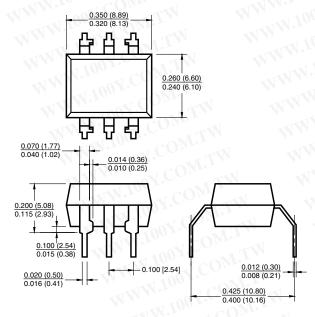
Through Hole



Surface Mount



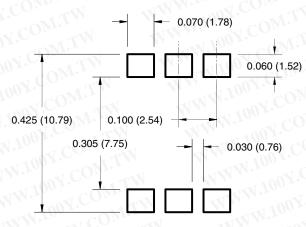
0.4" Lead Spacing



Note:

All dimensions are in inches (millimeters).

Recommend Pad Layout for Surface Mount Leadform



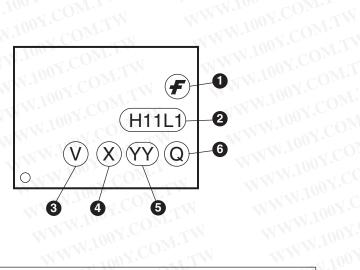
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Ordering Information

Option/Order Entry Identifier	Description
M MAN TOOK C	Surface Mount Lead Bend
201 2011	Surface Mount; Tape and reel
1. 1. 1. 1. 1. 1. 1. 1. 1. 1. 1. 1. 1. 1	0.4" Lead Spacing
TA W. 1003	VDE 0884
1.TW W 100	VDE 0884, 0.4" Lead Spacing
TIN WWW.	VDE 0884, Surface Mount
R2V	VDE 0884, Surface Mount, Tape & Reel

Marking Information

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	3 4 5
Definit	ions WWW.1007.COM.TW WV
1	Fairchild logo
2	Device number
C 3	VDE mark (Note: Only appears on parts ordered with VE option – See order entry table)
4	One digit year code, e.g., '3'
5	Two digit work week ranging from '01' to '53'
6	Assembly package code

*Note - Parts that do not have the 'V' option (see definition 3 above) that are marked with date code '325' or earlier are marked in portrait format.

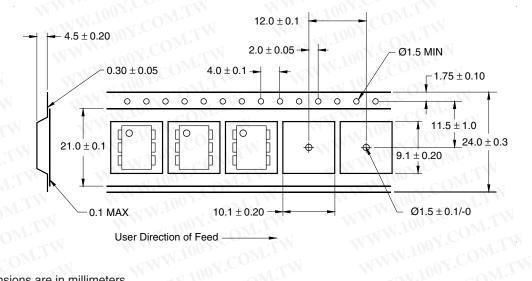
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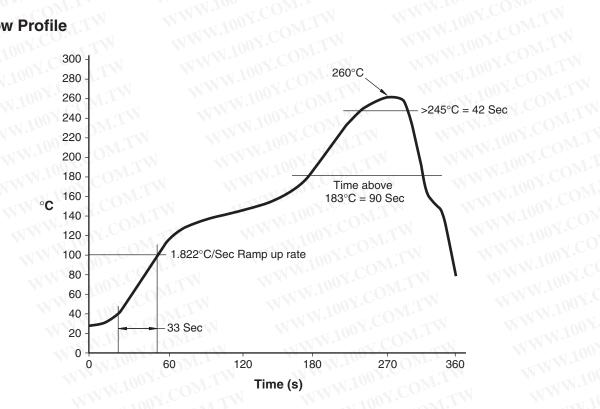
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Tape Dimensions



Note: All dimensions are in millimeters.

Reflow Profile



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PRODUCT STATUS DEFINITIONS

Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
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